

Spec. No. : Preliminary Data Issued Date : 2000.04.15 Revised Date : 2000.04.20 Page No. : 1/3

HSMA400X Series

1.0AMP. SURFACE MOUNT RECTIFIERS

Features

- For surface mounted application
- Low forward voltage drop
- High current capability
- Easy pick and place
- High surge current capability
- Plastic material used carries Underwriters Laboratory Classification 94V-0
- High temperature soldering: 250°C/10 seconds at terminals

Mechanical Data

- Case: SMA/DO-214AC Molded Plastic.
- Terminals: Solder plated.
- Polarity: Indicated by cathode band.
- Packaging: 12mm tape per EIA STD RS-481.
- Weight: 0.064 gram.

Maximum Ratings and Electrical Characteristics

Rating at 25°C ambient temperature unless otherwise specified. Single phase, half wave, 60Hz, resistive or inductive load. For capacitive load, derate current by 20%.

		-						
Type Number								Units
		4002	4003	4004	4005	4006	4007	01110
Maximum Recurrent Peak Reverse Voltage		100	200	400	600	800	1000	V
Maximum RMS Voltage		70	140	280	420	560	700	V
Maximum DC Blocking Voltage	50	100	200	400	600	800	1000	V
Maximum Average	Maximum Average						^	
Forward Rectified Current @TL=110°C	S							A
Peak Forward Surge Current, 8.3ms Single								
Half Sine-wave Superimposed on 30						Α		
Rated Load(JEDEC method)								
Maximum Instantaneous		1.1						V
Forward Voltage @ 1.0A	1.1						v	
Maximum DC Reverse Current at	5(@Ta=25°C)				uA			
Rated DC Blocking Voltage	50(@Ta=125°C)							
Maximum Reverse Recovery Time (Note 1)	1.8						uS	
Typical Junction Capacitance (Note 2)	12						pF	
Dperating Temperature Range Tj -55 to +150						°C		
Storage Temperature Range Tstg -55 to +150						°C		

Note1: Reverse Recovery Test Conditions: IF=0.5A, IR=1.0A, IRR=0.25A

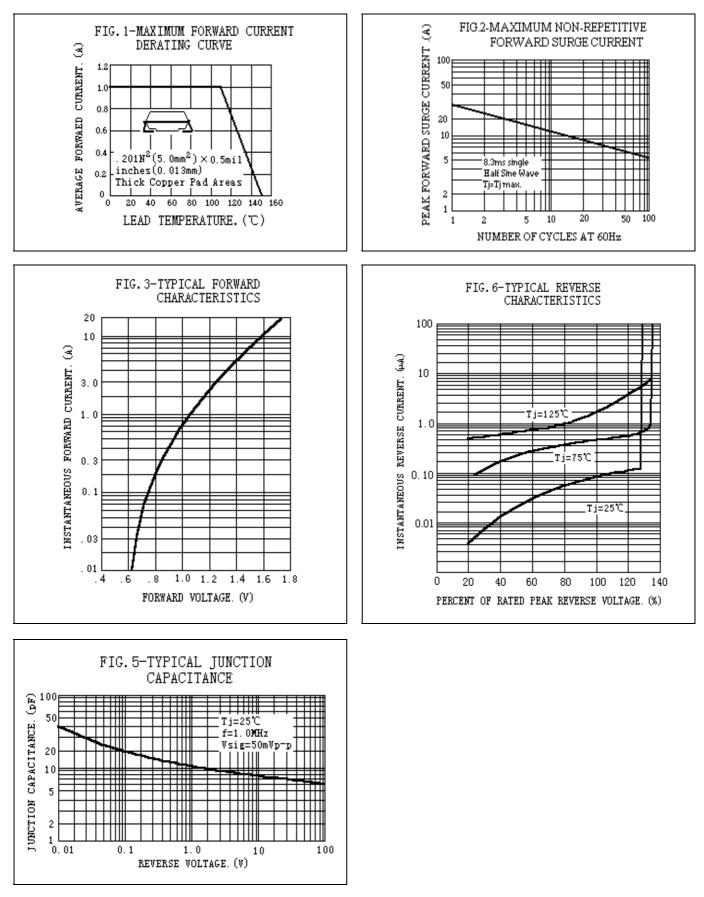
Note2: Measured at 1 MHz and Applied VR=4.0Volts



HI-SINCERITY MICROELECTRONICS CORP.

Spec. No. : Preliminary Data Issued Date : 2000.04.15 Revised Date : 2000.04.20 Page No. : 2/3

Characteristics Curve

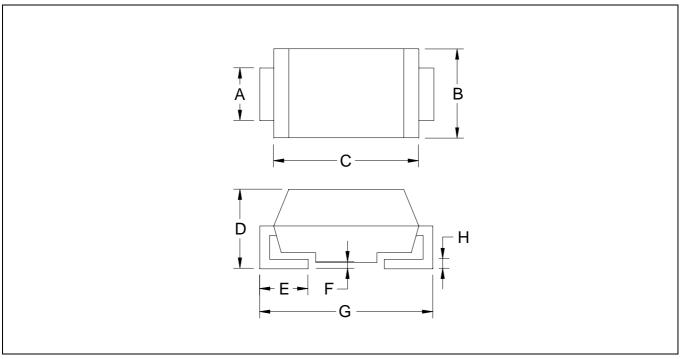




HI-SINCERITY MICROELECTRONICS CORP.

Spec. No. : Preliminary Data Issued Date : 2000.04.15 Revised Date : 2000.04.20 Page No. : 3/3

SMA/DO-214AC Dimension



	-		
∗.	1 \/r	bica	
	1 9 1	JICa	

. Typical									
DIM	Inches		Millimeters		DIM	Inches		Millimeters	
	Min.	Max.	Min.	Max.	DIVI	Min.	Max.	Min.	Max.
Α	0.5000	0.0642	1.27	1.63	Е	0.0299	0.0598	0.76	1.52
В	0.0901	0.1150	2.29	2.92	F	0.0039	0.0079	0.10	0.20
С	0.1575	0.1811	4.00	4.60	G	0.1890	0.2201	4.80	5.59
D	0.0783	0.1028	1.99	2.61	H	0.0059	0.0122	0.15	0.31

Notes: 1.Dimension and tolerance based on our Spec. dated Mar. 6,1995.

2.Controlling dimension : millimeters.

3.Maximum lead thickness includes lead finish thickness, and minimum lead thickness is the minimum thickness of base material. 4.If there is any question with packing specification or packing method, please contact your local HSMC sales office.

Material :

• Lead : 42 Alloy ; solder plating

• Mold Compound : Epoxy resin family, flammability solid burning class:UL94V-0

Important Notice:

• All rights are reserved. Reproduction in whole or in part is prohibited without the prior written approval of HSMC.

- HSMC reserves the right to make changes to its products without notice.
- HSMC semiconductor products are not warranted to be suitable for use in Life-Support Applications, or systems.
- HSMC assumes no liability for any consequence of customer product design, infringement of patents, or application assistance.

Head Office And Factory :

- Head Office (Hi-Sincerity Microelectronics Corp.) : 10F.,No. 61, Sec. 2, Chung-Shan N. Rd. Taipei Taiwan R.O.C. Tel : 886-2-25212056 Fax : 886-2-25632712, 25368454
- Factory 1 : No. 38, Kuang Fu S. Rd., Fu-Kou Hsin-Chu Industrial Park Hsin-Chu Taiwan. R.O.C
- Tel: 886-3-5983621~5 Fax: 886-3-5982931
- Factory 2 : No. 17-1, Ta-Tung Rd., Fu-Kou Hsin-Chu Industrial Park Hsin-Chu Taiwan. R.O.C
- Tel: 886-3-5977061 Fax: 886-3-5979220